

Top Board Dimensions



M1 Board Outline



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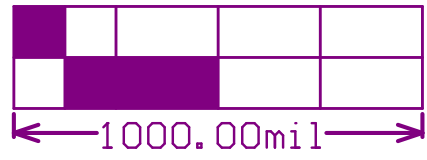
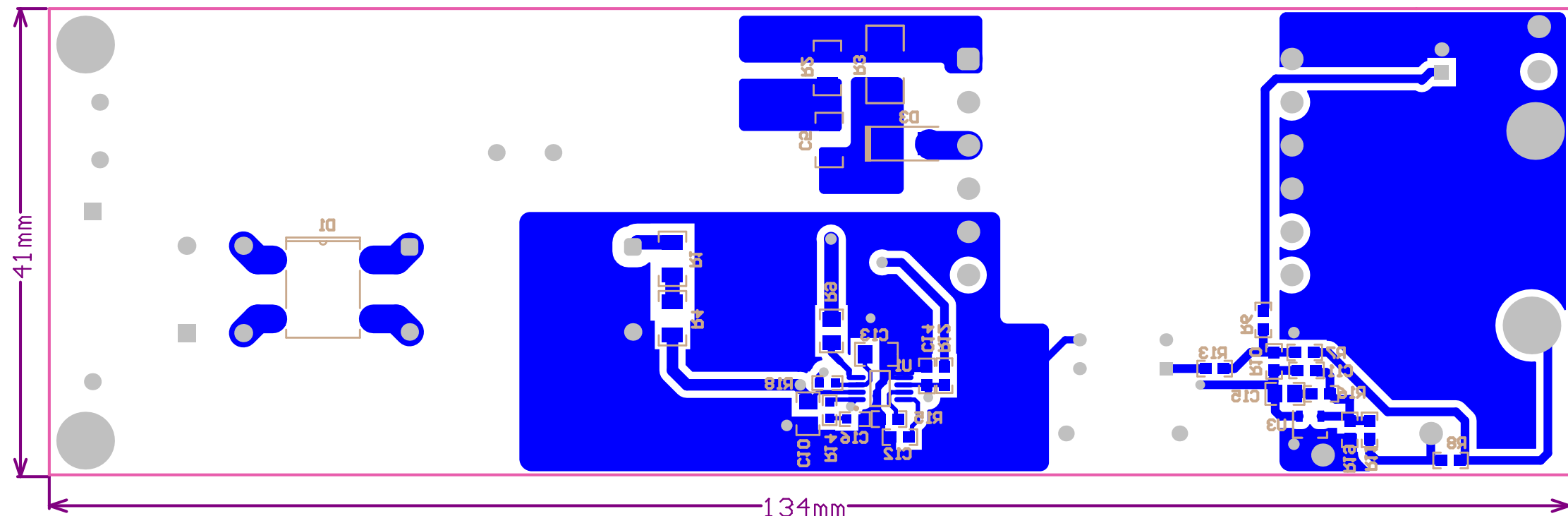


Fig. 10. Board Dimensions

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